

MMFTP6415KD-HAF

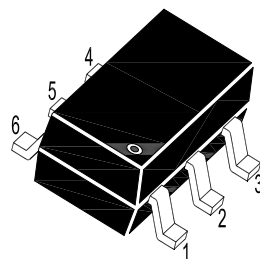
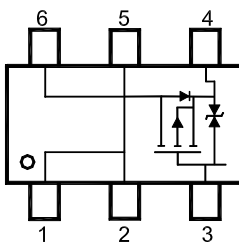
P-Channel Enhancement Mode MOSFET

Features

- Surface-mounted package
- Advanced trench cell design
- Halogen and Antimony Free(HAF), RoHS compliant

Applications

- Portable appliances
- Battery management
- High speed switch
- Low power DC to DC Converter



1. Drain 2. Drain 3. Gate
4. Source 5. Drain 6. Drain
SOT-26 Plastic Package

Absolute Maximum Ratings($T_a = 25^\circ\text{C}$)

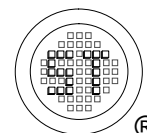
Parameter	Symbol	Value	Unit
Drain-Source Voltage	$-V_{DS}$	20	V
Gate-Source Voltage	V_{GS}	± 10	V
Continuous Drain Current $T_a = 25^\circ\text{C}$ $T_a = 70^\circ\text{C}$	$-I_D$	3.3 2.7	A
Peak Drain Current, Pulsed ¹⁾	$-I_{DM}$	17	A
Power Dissipation ²⁾ $T_a = 25^\circ\text{C}$ $T_a = 70^\circ\text{C}$	P_D	1.25 0.8	W
Operating Junction Temperature Range	T_j	- 55 to + 150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 55 to + 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient at $t \leq 10 \text{ s}$ ²⁾ Steady State	$R_{\theta JA}$	100 140	$^\circ\text{C/W}$

¹⁾ Repetitive rating, pulse width limited by junction temperature.

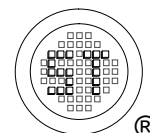
²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.



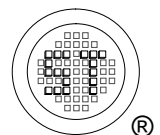
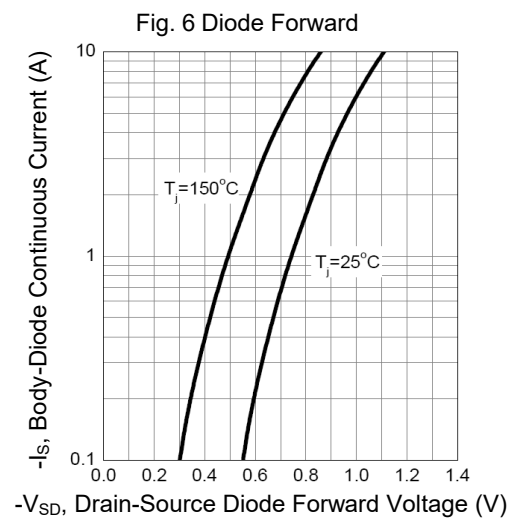
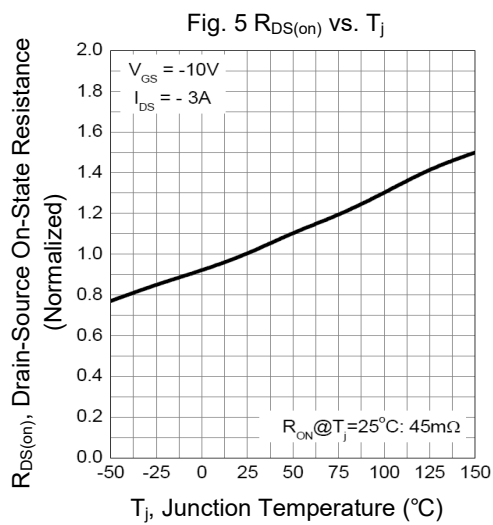
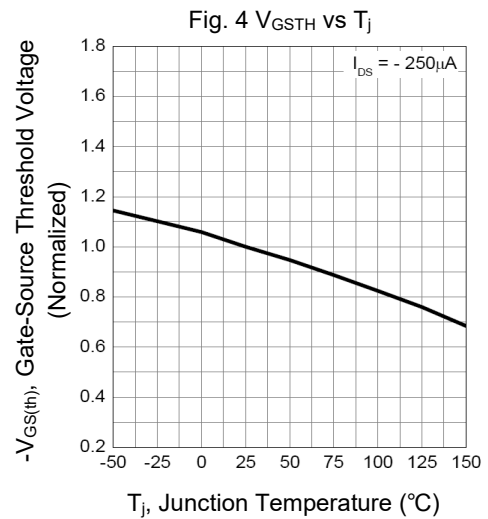
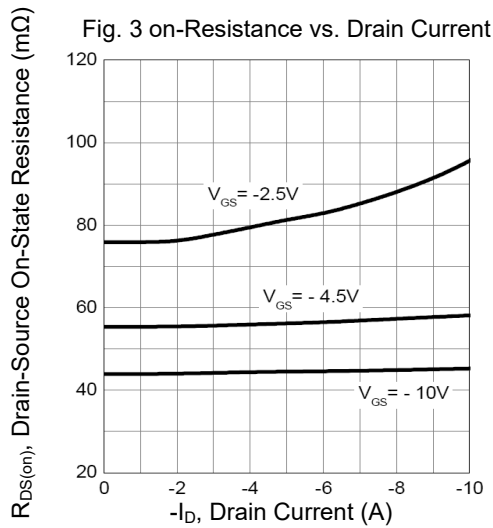
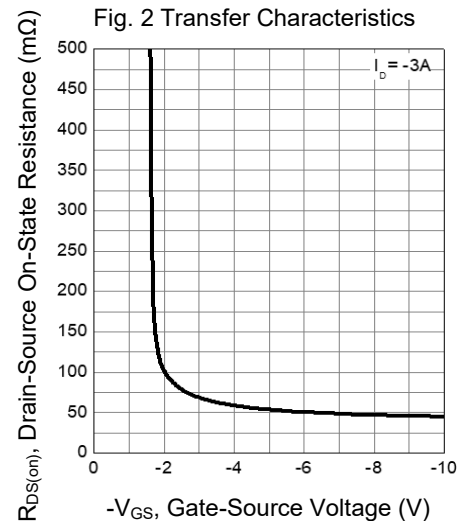
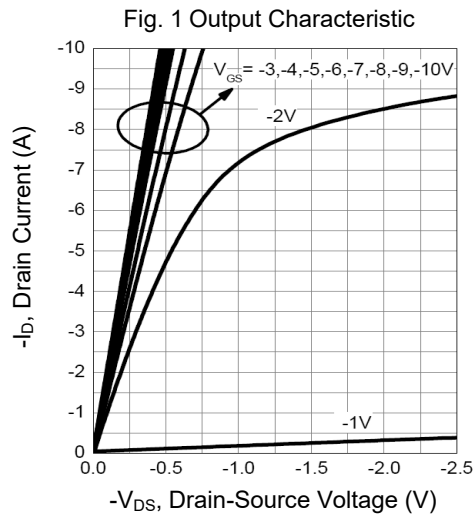
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Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

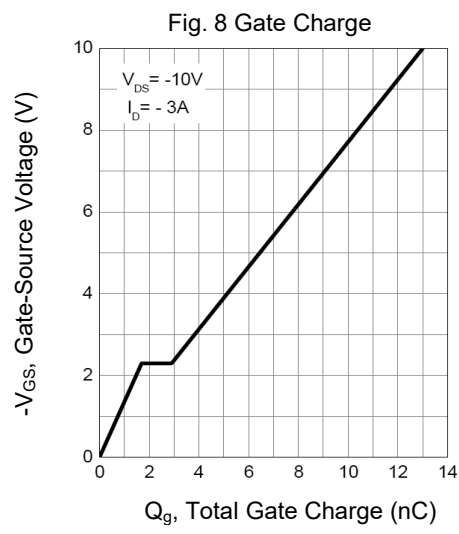
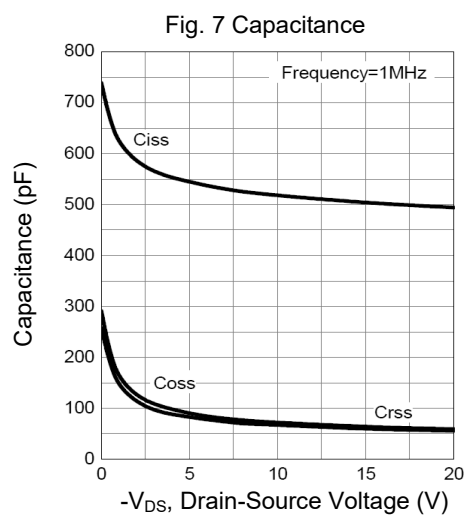
Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $-I_D = 250\ \mu\text{A}$	$-V_{(BR)DSS}$	20	-	-	V
Zero Gate Voltage Drain Current at $-V_{DS} = 20\ \text{V}$	$-I_{DSS}$	-	-	1	μA
Gate-Source Leakage at $V_{GS} = \pm 10\ \text{V}$	I_{GSS}	-	-	± 10	μA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $-I_D = 250\ \mu\text{A}$	$-V_{GS(th)}$	0.5	-	1.2	V
Drain-Source On-State Resistance at $-V_{GS} = 10\ \text{V}$, $-I_D = 3.3\ \text{A}$ at $-V_{GS} = 4.5\ \text{V}$, $-I_D = 2\ \text{A}$ at $-V_{GS} = 2.5\ \text{V}$, $-I_D = 1\ \text{A}$	$R_{DS(on)}$	- - -	- - -	82 100 140	m Ω
DYNAMIC PARAMETERS					
Forward Transconductance at $-V_{DS} = 5\ \text{V}$, $-I_D = 3.3\ \text{A}$	g_{fs}	-	8.6	-	S
Input Capacitance at $-V_{DS} = 10\ \text{V}$, $V_{GS} = 0\ \text{V}$, $f = 1\ \text{MHz}$	C_{iss}	-	518	-	pF
Output Capacitance at $-V_{DS} = 10\ \text{V}$, $V_{GS} = 0\ \text{V}$, $f = 1\ \text{MHz}$	C_{oss}	-	72	-	pF
Reverse Transfer Capacitance at $-V_{DS} = 10\ \text{V}$, $V_{GS} = 0\ \text{V}$, $f = 1\ \text{MHz}$	C_{rss}	-	67	-	pF
Total Gate Charge at $-V_{DS} = 10\ \text{V}$, $-I_D = 3\ \text{A}$, $-V_{GS} = 10\ \text{V}$	Q_g	-	13	-	nC
Gate Source Charge at $-V_{DS} = 10\ \text{V}$, $-I_D = 3\ \text{A}$, $-V_{GS} = 10\ \text{V}$	Q_{gs}	-	1.7	-	nC
Gate Drain Charge at $-V_{DS} = 10\ \text{V}$, $-I_D = 3\ \text{A}$, $-V_{GS} = 10\ \text{V}$	Q_{gd}	-	1.2	-	nC
Turn-On Delay Time at $-V_{DD} = 10\ \text{V}$, $-V_{GS} = 10\ \text{V}$, $-I_D = 3\ \text{A}$, $R_G = 4.5\ \Omega$, $R_L = 3.3\ \Omega$	$t_{d(on)}$	-	2.6	-	ns
Turn-On Rise Time at $-V_{DD} = 10\ \text{V}$, $-V_{GS} = 10\ \text{V}$, $-I_D = 3\ \text{A}$, $R_G = 4.5\ \Omega$, $R_L = 3.3\ \Omega$	t_r	-	34	-	ns
Turn-Off Delay Time at $-V_{DD} = 10\ \text{V}$, $-V_{GS} = 10\ \text{V}$, $-I_D = 3\ \text{A}$, $R_G = 4.5\ \Omega$, $R_L = 3.3\ \Omega$	$t_{d(off)}$	-	193	-	ns
Turn-Off Fall Time at $-V_{DD} = 10\ \text{V}$, $-V_{GS} = 10\ \text{V}$, $-I_D = 3\ \text{A}$, $R_G = 4.5\ \Omega$, $R_L = 3.3\ \Omega$	t_f	-	86	-	ns
Body-Diode PARAMETERS					
Body Diode Voltage at $-I_S = 1\ \text{A}$	$-V_{SD}$	-	-	1.3	V
Body Diode Reverse Recovery Time at $-I_F = 3\ \text{A}$, $di/dt = 100\ \text{A} / \mu\text{s}$	t_{rr}	-	38	-	ns
Body Diode Reverse Recovery Charge at $-I_F = 3\ \text{A}$, $di/dt = 100\ \text{A} / \mu\text{s}$	Q_{rr}	-	8.8	-	nC



Electrical Characteristics Curves



Electrical Characteristics Curves



Test Circuits

Fig.1-1 Switching times test circuit

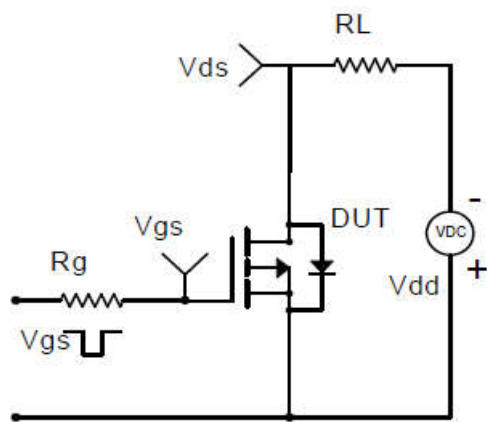


Fig.1-2 Switching Waveform

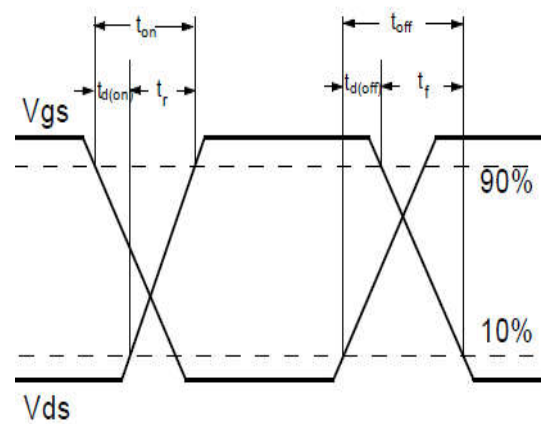


Fig.2-1 Gate charge test circuit

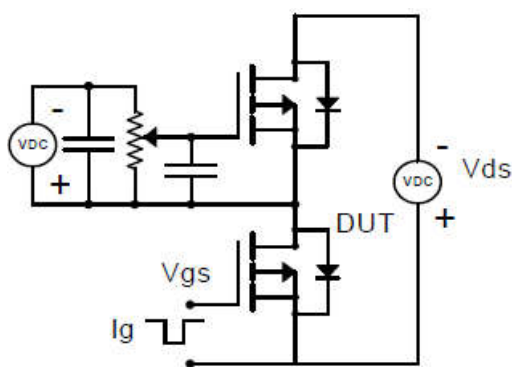
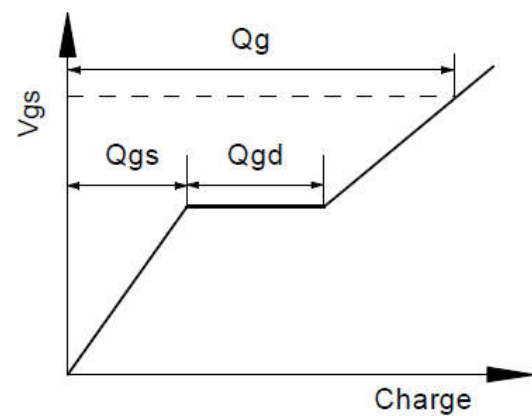


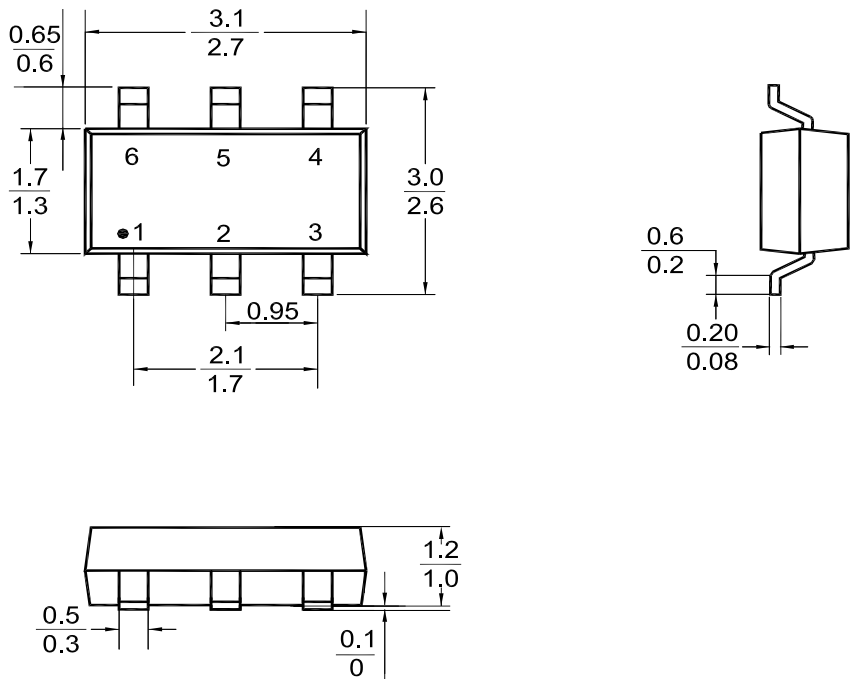
Fig.2-2 Gate charge waveform



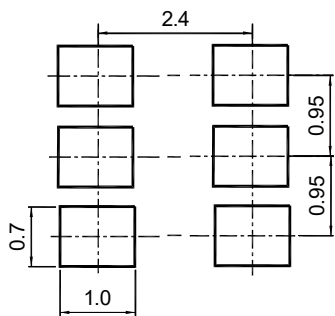
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Package Outline Dimensions (Units: mm)

SOT-26



Recommended Soldering Footprint



Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOT-26	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

"MN" = Part No.
"•" = HAF (Halogen and Antimony Free)
"YM" = Date Code Marking
"Y" = Year
"M" = Month
Font type: Arial

